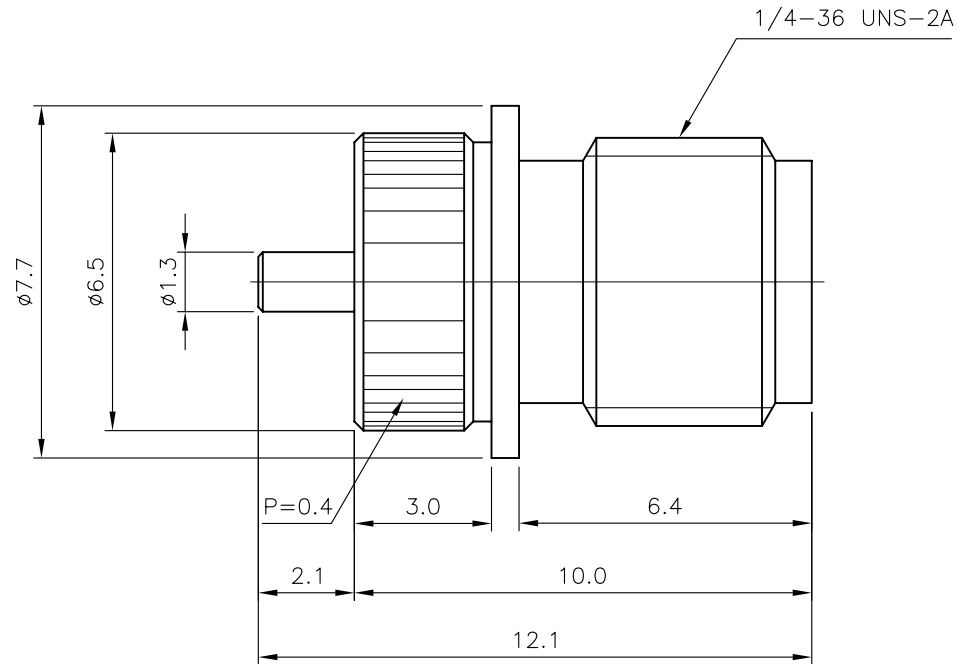


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	E.H.KIM	I.C.KIM	2013.06.26.



3	INSULATOR	1	TEFLON		DIN02196-N/1
2	CONTACT	1	BeCu	Gold Plate (1.27μm)	DCT00190-5/1
1	BODY	1	SUS303	Passivated	DBD00338-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2013. 06. 26.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	±1°	CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JB (F/P)
		DRAWN BY	E.H.KIM	
FINISH		SCALE	8/1	DWG NO. CN01388-7/2 REVISION I R SHEET 1 of 1
		UNIT	mm	

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